

SOLDER PASTE

BGA LEAD-FREE INSULATING SOLDER PASTE



N.W.:50G

Melting point 60°C



Product Usage



TIN PASTE

Name	Lead-free insulating solder paste
Model	559A
Product Category	Lead-free, lacto-free
Product color	light yellow
Melting point	60°C
Conductivity	insulation
size	φ71*27mm
N.W.	50g
G.W.	62g

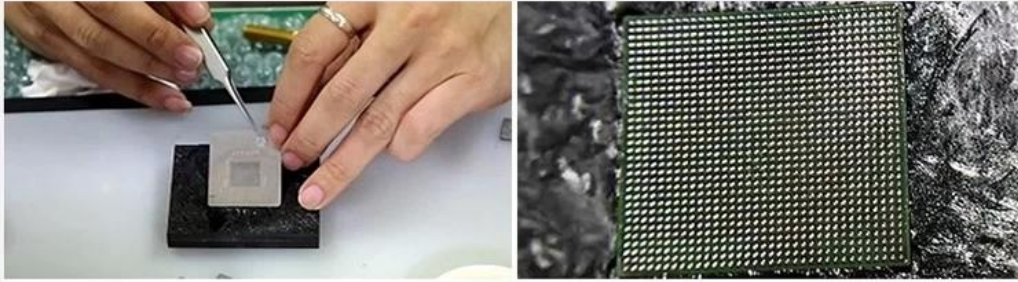
Lead-free insulating solder paste

Strong activity

No resistance



Meet different soldering needs



CPU plant tin



Circuit board



Welding



Electric motherboard



computer



Home appliances

Product testing

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Testing effect



RESISTANCE TEST

Hot air gun blowing out
Effect test

Moderate viscosity,
Good rheology



RESISTANCE TEST

Blow-out effect

Strong activity, no resistance
Non-conductive, less residue

BST-559A

Highly active / halogen-free / lead-free / no resistance / non-conductive

Lead-free insulating solder paste

Milky white paste, suitable for BGA repair,
Used by people with high solder requirements.

50g



Product Size



G.W.:62g

